

Andor iKon-M/L SO Series

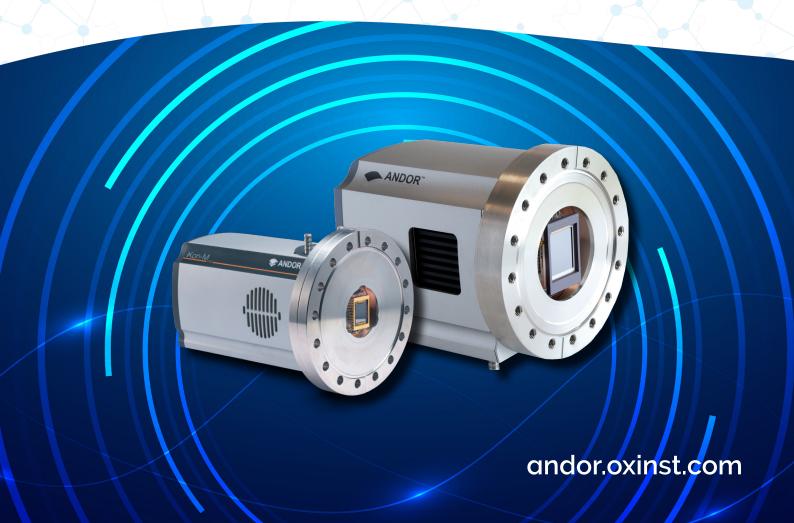
Open Front CCD Direct Detection Imaging

Key Specifications

- ✓ 1 MP or large area 4.2 MP sensors
- ✓ Peak QE up to 95% (soft x-ray region)
- ✓ High resolution 13 or 13.5 µm pixels
- ✓ TE-cooling down to -100°C
- ✓ Readout noise as low as 2.9 e-
- ✓ Labview and EPICS compatibility
- ✓ USB 2.0 Interface

Key Applications

- √ VUV/EUV/XUV Imaging
- √ X-Ray Imaging & Microscopy
- ✓ X-Ray Diffraction (XRD)
- ✓ X-Ray Plasma Imaging
- √ X-Ray source characterization
- ✓ X-Ray Phase Contrast Imaging
- ✓ High Harmonic Generation (HHG)



Introducing iKon-M/L SO

High Resolution, High Sensitivity and High Dynamic Range 'Direct' Detection

Andor's iKon series offers outstanding sensitivity performance through a combination of > 95% QE back-illuminated sensors, low noise readout electronics and industry-leading, maintenance-free deep TE-cooling down to -100°C. It features high resolution 1 and 4.2 Megapixel large area sensor options (with 13 and 13.5 µm pixels respectively) for simultaneous high dynamic range and high spatial resolution imaging in the VUV and soft X-ray range.

A convenient 16-point, knife-edge sealed 6" rotatable CF-152 flange provides a robust and highly-effective seal to any compatible vacuum chamber interface. The iKon-M and -L also offer a USB2 interface and Labview or EPICS compatibility for seamless integration into complex setups.

Meet the Family





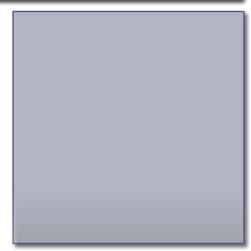


iKon-M SO	iKon-L SO	iKon-XL SO*
• 1 MP (13 µm pixels) •-100°C TE cooling •>95% • Down to 2.9 e ⁻ • Up to 100 000 e ⁻ • 4.4 fps • DN100CF / 6" CF / CF-152 rotatable flange and knife-edge	 4.2 MP (13.5 µm pixels) -100°C TE cooling >95% Down to 2.9 e⁻ Up to 150 000 e⁻ 0.953 fps DN100CF / 6" CF / CF-152 flange and knife-edge 	 16.8 MP (15 µm pixels) -75°C TE cooling >95% Down to 2.1 e⁻ Up to 350 000 e⁻ Up to 0.5 fps (full frame) DN160CF / 8" CF / CF-203 rotatable flange and knife-edge





27.6 x 27.6 mm



61.4 x 61.7 mm

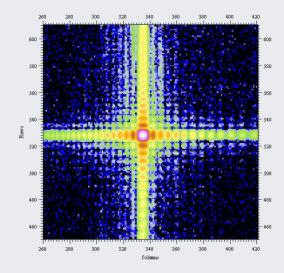
Above: Comparison of the sensor size of the iKon family (actual size). *For more information about the iKon-XL platform, please go to andor.oxinst.com/products/cameras-for-x-ray-euv-electron-and-neutron-detection



Features & Benefits

Feature	Benefit
Open-front end	DN100CF / 6 " CF / CF-152 flange and knife-edge sealing provided as standard for direct interfacing to vacuum chambers (rotatable design for iKon-M models).
1 MP and 4.2 MP sensor options	Choice of acquisition speed or large field-of-view to best match experimental needs.
13 x 13 and 13.5 x 13.5 μm pixel size options	Ideal balance of dynamic range and resolution, on-head binning to extend dynamic range.
Peak QE up to 95%	High photon collection efficiency for maximising signal-to-noise ratios. 'Enhanced' process back-illuminated sensor options for increased QE in the soft x-ray range.
Thermo-electric cooling down to -100°C	Efficiently minimizes dark current noise for acquisitions requiring longer sensor exposure time, obtain better signal-to-noise ratios faster.
Low noise readout down to 2.9 e-	Intelligent low-noise electronics offer the most 'silent' system noise.
Up to 5 MHz pixel readout speed	Slow readout for low noise and best SNR performance, faster speed for studying dynamic processes and 5 MHz focusing mode.
USB 2.0 interface	Built-in robust plug and play interface as standard.
Cropped sensor mode	Tracking stability to ensure all readout circuits experience same temperature and operating conditions.
Enhanced baseline clamp	Slower readout for lowest noise, faster speeds for more rapid readout and focusing.
Windows, Linux & Labview	Andor's user-friendly SDK supports both Windows and Linux OS. LabView VI package available.
Integrated in EPICS	Seamless integration and operation at EPICS-based particle accelerators.
Filter and filter holders options	Accommodate beryllium (or aluminium) windows with thickness down to 200 μ m for removal of unwanted lower energy radiations (< 2 keV). Ø45.5 mm supported for iKon-M and Ø60 mm for iKon-L.

iKon-M/L SO Application Images



X-ray diffraction pattern of the Synchrotron Soleil, France obtained with a iKon-M SO. *Courtesy of Vincent Jacques*.



XRD Powder diffraction image obtained with an iKon-L SO. Courtesy of NASA AMES, USA

Technical Data

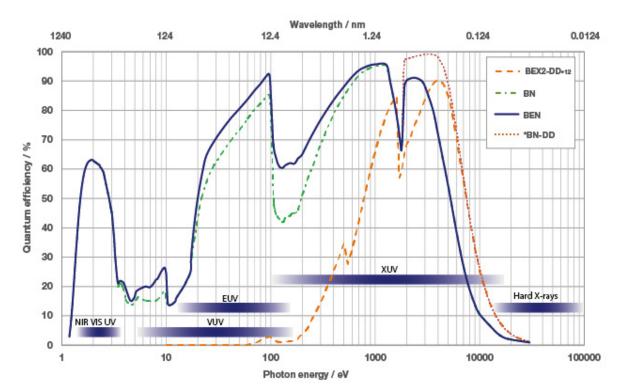
System Specifications •2

	iKon-M SO	iKon-L SO	
Sensor Options	BN: Back-illuminated CCD, uncoated NEW BEN: Back-illuminated CCD, enhanced process, uncoated		
Pixels ^{●3}	1024 × 1024	2048 × 2048	
Pixel size	13 x 13 µm	13.5 x 13.5 μm	
Image area	13.3 x 13.3 mm with 100% fill factor	27.6 x 27.6 mm with 100% fill factor	
Minimum temperatures ^{•4} Air cooled Coolant recirculator Coolant chiller coolant @10°C 0.75l/min	-80°C -95°C -100°C	-80°C -95°C -100°C	
Blemish specification	Grade 1 sensor from supplier. Camera blemishes as defined by Andor Grade A andor.oxinst.com/learning/view/article/ccd-blemishes-and-non-uniformities		

Advanced Performance Specifications •2

	iKon-M SO		iKon-	-L SO	
Peak QE ^{●5}	>95% (BN/BEN)				
Active area pixel well depth (typical)	BN/BEN/BR-DD 150,000 e ⁻		_	BEN 000 e ⁻	
Output node capacity	250,000 e ⁻		1,000,	000 e-	
Pixel readout rates	0.0	5, 1, 3 and 5 M	Hz		
Read Noise (e ⁻)	BN/BEN	ВМ	N	ВЕ	N
0.05 MHz 1 MHz 3 MHz 5 MHz	2.9 6.6 11.6 18.0	High Sensitivity 2.9 7.0 11.7 31.5	High Capacity 8.7 22.2 40.2 70.3	High Sensitivity 4.3 6.8 11.7 34.1	High Capacity 9.5 21.8 36.3 69.4
Dark Current, e ⁻ /pixel/sec ^{•6} @ -70°C @ -80°C @ -100°C	0.0016 0.0016 0.066 0.0004 0.0004 0.0151 0.0001 0.0001 0.0008		.51		
Frame rate (full frame)	4.4 fps		0.95	3 fps	
Linearity •7	Better than 99%				
Digitization	16-bit (all speeds)				
Mounting flange	DN100CF / 6" CF / CF-152				
Maximum bake-out temperature	+55°C				
Vacuum compatibility	>10 ⁻⁸ millibar				

Quantum Efficiency Curves •5



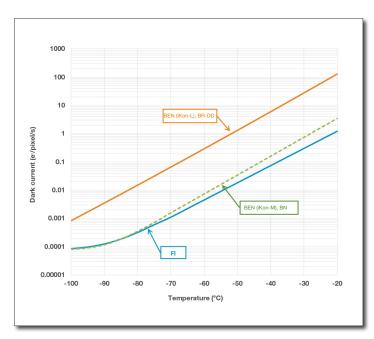
Kev:

VUV: Vacuum Ultraviolet, **EUV**: Extreme Ultraviolet, **XUV**: Extreme Ultraviolet (X-ray)

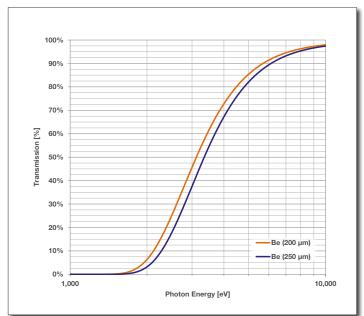
For more information about Andor solutions for 'indirect' detection please go to <u>andor.oxinst.com/products/cameras-for-x-ray-euv-electron-and-neutron-detection</u>

*Note BN-DD has the same QE as BN below 1800 eV

Dark Current



Beryllium Window Transmission



Frame Rates⁶⁸

iKon-M SO

50 kHz Precision photometry mode						
Binning	Full Frame 512 x 512 256 x 256 128 x 1					
1 x 1	0.04	0.1	0.2	0.4		
2 x 2	0.2	0.2	0.4	0.8		
4 x 4	0.6	0.6	0.9	1.5		
8 x 8	2.0	1.2	1.7	2.8		
16 x 16	5.1	2.3	3.2	5.0		

3 MHz					
Binning	Full Frame	512 x 512	256 x 256	128 x 128	
1 x 1	2.6	5.2	10.0	18.6	
2 x 2	6.3	10.9	19.3	33.2	
4 x 4	13.4	20.9	34.2	53.5	
8 x 8	25.1	36.3	54.4	76.5	
16 x 16	41.5	56.1	76.5	97.1	

1 MHz					
Binning	Full Frame	512 x 512	256 x 256	128 x 128	
1 x 1	0.9	1.8	3.5	6.9	
2 x 2	2.9	4.3	7.5	13.5	
4 x 4	7.9	9.4	14.8	24.6	
8 x 8	18.0	18.2	26.6	40.7	
16 x 16	33.4	31.6	43.0	59.8	

	5 MHz Visualization mode •9						
Binning	ng Full Frame 512 x 512 256 x 256 128 x 128						
1 x 1	4.4	8.5	16.0	28.8			
2 x 2	8.4	15.9	28.5	47.6			
4 x 4	15.6	28.1	47.0	70.8			
8 x 8	27.3	45.8	69.4	93.5			
16 x 16	43.6	66.9	91.2	111.5			

iKon-LSO

50 kHz Precision photometry mode						
Binning	Full Frame	1024 x 1024	512 x 512			
1 x 1	0.011	0.023	0.046			
2 x 2	0.040	0.059	0.102			
4 x 4	0.155	0.138	0.213			
8 x 8	0.482	0.293	0.420			
16 x 16	1.166	0.572	0.780			

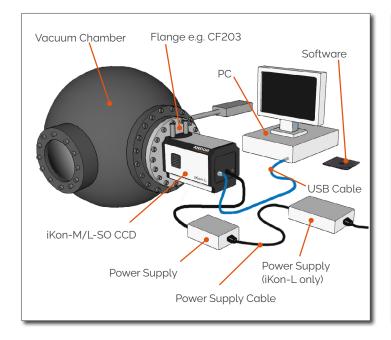
3 MHz						
Binning	Full Frame	1024 x 1024	512 x 512			
1 x 1	0.607	1.157	2.115			
2 x 2	1.294	2.175	3.588			
4 x 4	2.305	3.545	5.326			
8 x 8	3.463	5.017	6.953			
16 x 16	4.496	6.270	8.180			

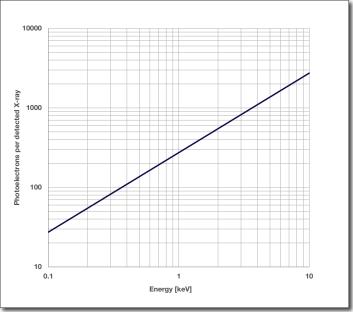
1 MHz						
Binning	Full Frame	1024 x 1024	512 x 512			
1 x 1	0.221	0.433	0.835			
2 x 2	0.662	0.993	1.670			
4 x 4	1.594	1.947	2.951			
8 x 8	2.912	3.266	4.571			
16 x 16	4.152	4.710	6.204			

5 MHz Visualization mode ^{*9}						
Binning Full Frame 1024 x 1024 512 x 512						
1 x 1	0.953	1.771	3.100			
2 x 2	1.655	2.922	4.733			
4 x 4	2.619	4.329	6.424			
8 x 8	3.697	5.700	7.822			
16 x 16	4.654	6.776	8.777			

Typical Set-up

Photoelectrons vs Incident X-rays •10





Best Practice Guidelines

Condensation

- It is strongly advised that the camera should not be used in a condensing atmosphere.
- If used in a condensing atmosphere the sensor MUST be protected and the use of a cold finger is strongly recommended.

Contamination & Damage

- When not in use, the sensor chamber should be covered and sealed.
- Due to the exposed nature of the sensor, extreme care should be taken with the camera, as damage can easily occur through mishandling or by
 contamination.
- If the sensor becomes contaminated, due to accident or misuse, please contact Andor immediately for advice on cleaning.

Vacuum Operations

- Ensure that the vacuum environment to which the camera is fitted is free of water vapour and other contaminants.
- Care should also be taken to control pressure change, as sudden pressure changes can potentially cause damage to the sensor assembly.

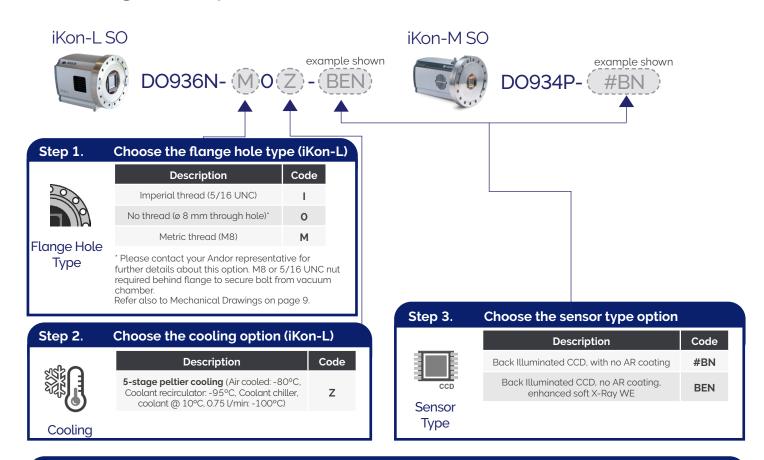
Vacuum Units Equivalences

Vacuum Regime	Pressure Range			
	mBar	bar	pascal (Pa)	Torr
Atmospheric pressure	1.013x10 ⁺³	1.013	1.013x10 ⁺⁵	7.6×10 ⁺²
High vacuum	1x10 ⁻³ to 1x10 ⁻⁹	1x10 ⁻⁶ to 1x10 ⁻¹²	1x10 ⁻¹ to 1x10 ⁻⁷	7.5×10 ⁻⁴ to 7.5×10 ⁻¹⁰
Ultra high vacuum	1x10 ⁻⁹ to 1x10 ⁻¹²	1x10 ⁻¹² to 1x10 ⁻¹⁵	1x10 ⁻⁷ to 1x10 ⁻¹⁰	7.5×10 ⁻¹⁰ to 7.5×10 ⁻¹³
Extremely high vacuum	<1×10 ⁻¹²	<1×10 ⁻¹⁵	<1×10 ⁻¹⁰	<1×10 ⁻¹³



Please refer to the Andor Technical Note: <u>Open-front camera flanges</u> for further details.

Creating The Optimum Product for You



Step 4.	Select the required accessories and adapters	
	Description	Order Code
	Re-circulator for enhanced cooling performance	XW-RECR
	Oasis 160 Ultra compact chiller unit (tubing to be ordered separately)	ACC-XW-CHIL-160
	6 mm tubing options for ACC-XW-CHIL-160 (2x2.5 m or 2x5 m lengths)	ACC-6MM-TUBING-2X2.5/ ACC-6MM-TUBING-2X5M
	USB Extender: Icron USB 2.0 Ranger 2311 (supports up to 100 m) - EU/UK/US	ACC-USBX-EU ACC-USBX-UK ACC-USBX-US
Accessories & Adapters	30 m Ethernet cable (for use with the above ACC-USBX-** USB extenders)	ACC-ELC-13295
	Optional filter holder for iKon-L only (supplied as standard for iKon-M)	SO-FILTER-MNT-IKONL
	Copper gasket for DN100CF / 6 " CF open-front camera knife-edge vacuum seal	ACC-FLG-SO-GSKT-CU

Step 5. Select the required software

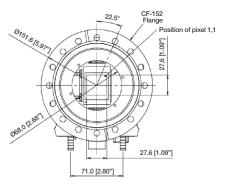


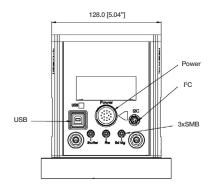
The iKon-M/L SO require at least one of the following software options:

Solis Imaging A 32-bit and fully 64-bit enabled application for Windows (8, 8.1, 10 and 11) offering rich functionality for data acquisition and processing. AndorBasic provides macro language control of data acquisition, processing, display and export. Andor SDK A software development kit that allows you to control the Andor range of cameras from your own application. Available as 32/64-bit libraries for Windows (8, 8.1, 10 and 11), compatible with C/C++, C#, Delphi, VB.NET, LabVIEW and Matlab. Linux SDK compatible with C/C++.

Mechanical Drawings

iKon-LSO

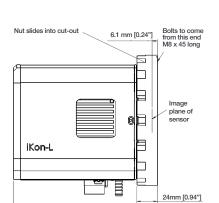




Third-angle projection Dimensions in mm [inches] Water Connectors (x2) to suit 6.0mm ID soft PVC hose

Attachment options:





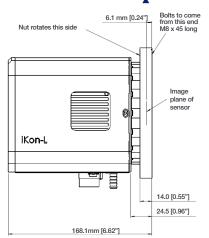
168.1mm [6.62"]



Variation: no thread, non-captive nuts

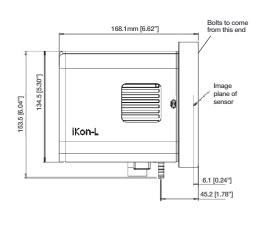
Please contact your Andor representative for further details about this option

e.g. D0936N-00Z-#BN-**9QJ**

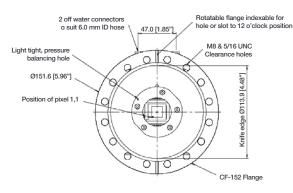


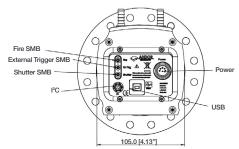


USB

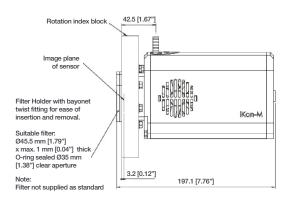


iKon-MSO





Note: Please contact us for further information on attachment options



Connecting to the iKon-M & -L SO Camera Control: Connector type: USB 2.0

TTL / Logic: Connector type: SMB, provided with SMB - BNC cable Fire (Output), External Trigger (Input), Shutter (Output)

 $\rm l^2C$ connector: Compatible with Fischer SC102A054-130 Shutter (TTL), $\rm l^2C$ Clock, $\rm l^2C$ Data, +5 Vdc, Ground

Minimum cable clearance required at bottom of camera: 100 mm



Order Today

At Andor we are committed to finding the correct solution for you. With a dedicated team of technical advisors, we are able to offer you one-to-one guidance and technical support on all Andor products.

For a full listing of our local sales offices, please see: andor.com/contact

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China

Beijing Phone +86 (10) 5884 7900 Fax +86 (10) 5884 7901



Items shipped with your camera:

1 x 2 m BNC - SMB connection cable

1 x 3 m USB 2.0 cable Type A - Type B

1 x Power supply with mains cable (iKon-M)

2 x Power supplies with associated cables (iKon-L)

3.0 GHz single core or 2.4 GHz multi core

100 MB free hard disc to install software (at

least 1GB recommended for data spooling)

USB 2.0 High Speed Host Controller capable

1 x CD containing Andor user guides

1 x Individual system performance booklet

Minimum Computer Requirements

1 x Protective cover plate

4 x Fixing screws for cover plate •11

Footnotes: Specifications are subject to change without notice

- IMPORTANT Due to the sensor being exposed to environments outside of Andor's control there is no warranty on the sensor. For full details of Andor's Warranty Policy please refer to our webpage at www.andor.com/contact_us/support_request/. For key information on handling precautions for SO/ HO open front end systems, please refer to the best practice guidelines on page 7. Note permanent damage can easily occur due to misuse
- 2. Figures are typical unless otherwise stated.
- 3. Edge pixels may exhibit a partial response
- 4. Stabilized cooling temperatures are given for slowest readout speed. Use of faster readout speeds (in order to achieve faster frame rates) may require a higher cooling temperature to be selected. Specified minimum air cooled temperature assumes ambient temperature of 25°C. Specified minimum temperature with coolant assumes coolant temperature of 10°C. All cooling performance can be compromised by the environment to which the sensor is exposed.
- 5. Quantum efficiency as supplied by the sensor manufacturer.
- 6. Dark current measurement is averaged over the CCD area excluding any regions of blemishes.
- 7. Linearity is measured from a plot of counts vs exposure time under constant photon flux up to the saturation point of the system.
- Typical binning or array size combinations, All measurements are made with 4.25 us (iKon-M), and 38.55 µs (iKon-L) vertical shift speed. It also assumes internal trigger mode of operation and minimum
- 9. 5 MHz is for focusing/visualization mode only.
- 10. The graph shows photoelectrons generated as a function of photon energy of incident X-ray.
- 11. Fixing screws for mounting the flange to a vacuum chamber are not included.
- 12. BEX2-DD sensor is available through our Customer Special Request process please contact your sales representative.

Windows (8, 8.1, 10 and 11) or Linux Weight (approx)

processor

- iKon-M SO: 4.9 kg [10 lb 13 oz]
- iKon-L SO: 5.5 kg [12 lb 2 oz]

Operating & Storage Conditions

of sustained rate of 40 MB/s

- Operating Temperature: 0°C to 30°C ambient
- Relative Humidity: < 70% (non-condensing)
- Storage Temperature: -25°C to 50°C Maximum Bakeout: Temperature +55°C

Power Requirements

100 - 240 VAC, 50 - 60 Hz

Power Consumption:

- iKon-M 48 W max
- iKon-L with 5 stage cooler (Z) 120 W max



















Windows is a registered trademark of Microsoft Corporation. Labview is a registered trademark of National Instruments. Matlab is a registered trademark of The MathWorks Inc. EPICS support in 16-bit mode only.